



RF Power Field Effect Transistors

N-Channel Enhancement-Mode Lateral MOSFETs

Designed for CDMA base station applications with frequencies from 920 to 960 MHz. Can be used in Class AB and Class C for all typical cellular base station modulation formats.

- Typical Single-Carrier W-CDMA Performance: $V_{DD} = 28$ Volts, $I_{DQ} = 1600$ mA, $P_{out} = 65$ Watts Avg., IQ Magnitude Clipping, Channel Bandwidth = 3.84 MHz, Input Signal PAR = 7.5 dB @ 0.01% Probability on CCDF.

Frequency	G_{ps} (dB)	η_D (%)	Output PAR (dB)	ACPR (dBc)
920 MHz	19.7	35.1	6.1	-37.4
940 MHz	19.8	35.3	6.2	-37.5
960 MHz	19.4	35.7	6.1	-37.4

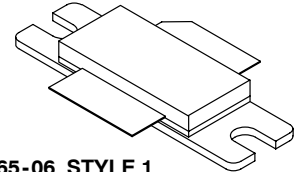
- Capable of Handling 10:1 VSWR, @ 32 Vdc, 940 MHz, 317 Watts CW Output Power (3 dB Input Overdrive from Rated P_{out}), Designed for Enhanced Ruggedness
- Typical P_{out} @ 1 dB Compression Point \approx 220 Watts CW

Features

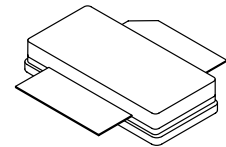
- 100% PAR Tested for Guaranteed Output Power Capability
- Characterized with Series Equivalent Large-Signal Impedance Parameters and Common Source S-Parameters
- Internally Matched for Ease of Use
- Integrated ESD Protection
- Greater Negative Gate-Source Voltage Range for Improved Class C Operation
- Designed for Digital Predistortion Error Correction Systems
- Optimized for Doherty Applications
- RoHS Compliant
- In Tape and Reel. R3 Suffix = 250 Units per 56 mm, 13 inch Reel.

MRF8S9220HR3
MRF8S9220HSR3

920-960 MHz, 65 W AVG., 28 V
SINGLE W-CDMA
LATERAL N-CHANNEL
RF POWER MOSFETs



CASE 465-06, STYLE 1
NI-780
MRF8S9220HR3



CASE 465A-06, STYLE 1
NI-780S
MRF8S9220HSR3

Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
Drain-Source Voltage	V_{DSS}	-0.5, +70	Vdc
Gate-Source Voltage	V_{GS}	-6.0, +10	Vdc
Operating Voltage	V_{DD}	32, +0	Vdc
Storage Temperature Range	T_{stg}	-65 to +150	$^{\circ}C$
Case Operating Temperature	T_C	150	$^{\circ}C$
Operating Junction Temperature (1,2)	T_J	225	$^{\circ}C$

Table 2. Thermal Characteristics

Characteristic	Symbol	Value (2,3)	Unit
Thermal Resistance, Junction to Case Case Temperature 81 $^{\circ}C$, 65 W CW, 28 Vdc, $I_{DQ} = 1600$ mA	$R_{\theta JC}$	0.39	$^{\circ}C/W$
Case Temperature 81 $^{\circ}C$, 220 W CW, 28 Vdc, $I_{DQ} = 1600$ mA		0.32	

1. Continuous use at maximum temperature will affect MTTF.
2. MTTF calculator available at <http://www.freescale.com/rf>. Select Software & Tools/Development Tools/Calculators to access MTTF calculators by product.
3. Refer to AN1955, *Thermal Measurement Methodology of RF Power Amplifiers*. Go to <http://www.freescale.com/rf>. Select Documentation/Application Notes - AN1955.

Table 3. ESD Protection Characteristics

Test Methodology	Class
Human Body Model (per JESD22-A114)	1C (Minimum)
Machine Model (per EIA/JESD22-A115)	A (Minimum)
Charge Device Model (per JESD22-C101)	IV (Minimum)

Table 4. Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
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Off Characteristics

Zero Gate Voltage Drain Leakage Current ($V_{DS} = 70\text{ Vdc}$, $V_{GS} = 0\text{ Vdc}$)	I_{DSS}	—	—	10	μAdc
Zero Gate Voltage Drain Leakage Current ($V_{DS} = 28\text{ Vdc}$, $V_{GS} = 0\text{ Vdc}$)	I_{DSS}	—	—	1	μAdc
Gate-Source Leakage Current ($V_{GS} = 5\text{ Vdc}$, $V_{DS} = 0\text{ Vdc}$)	I_{GSS}	—	—	1	μAdc

On Characteristics

Gate Threshold Voltage ($V_{DS} = 10\text{ Vdc}$, $I_D = 400\ \mu\text{Adc}$)	$V_{GS(th)}$	1.5	2.2	3	Vdc
Gate Quiescent Voltage ($V_{DD} = 28\text{ Vdc}$, $I_D = 1600\text{ mAdc}$, Measured in Functional Test)	$V_{GS(Q)}$	2.3	3.1	3.8	Vdc
Drain-Source On-Voltage ($V_{GS} = 10\text{ Vdc}$, $I_D = 4\text{ Adc}$)	$V_{DS(on)}$	0.1	0.2	0.3	Vdc

Functional Tests ⁽¹⁾ (In Freescale Test Fixture, 50 ohm system) $V_{DD} = 28\text{ Vdc}$, $I_{DQ} = 1600\text{ mA}$, $P_{out} = 65\text{ W Avg.}$, $f = 960\text{ MHz}$, Single-Carrier W-CDMA, IQ Magnitude Clipping, Input Signal PAR = 7.5 dB @ 0.01% Probability on CCDF. ACPR measured in 3.84 MHz Channel Bandwidth @ $\pm 5\text{ MHz}$ Offset.

Power Gain	G_{ps}	18.0	19.4	21.0	dB
Drain Efficiency	η_D	34.0	35.7	—	%
Output Peak-to-Average Ratio @ 0.01% Probability on CCDF	PAR	5.7	6.1	—	dB
Adjacent Channel Power Ratio	ACPR	—	-37.4	-35	dBc
Input Return Loss	IRL	—	-13	-8	dB

Typical Broadband Performance (In Freescale Test Fixture, 50 ohm system) $V_{DD} = 28\text{ Vdc}$, $I_{DQ} = 1600\text{ mA}$, $P_{out} = 65\text{ W Avg.}$, Single-Carrier W-CDMA, IQ Magnitude Clipping, Input Signal PAR = 7.5 dB @ 0.01% Probability on CCDF. ACPR measured in 3.84 MHz Channel Bandwidth @ $\pm 5\text{ MHz}$ Offset.

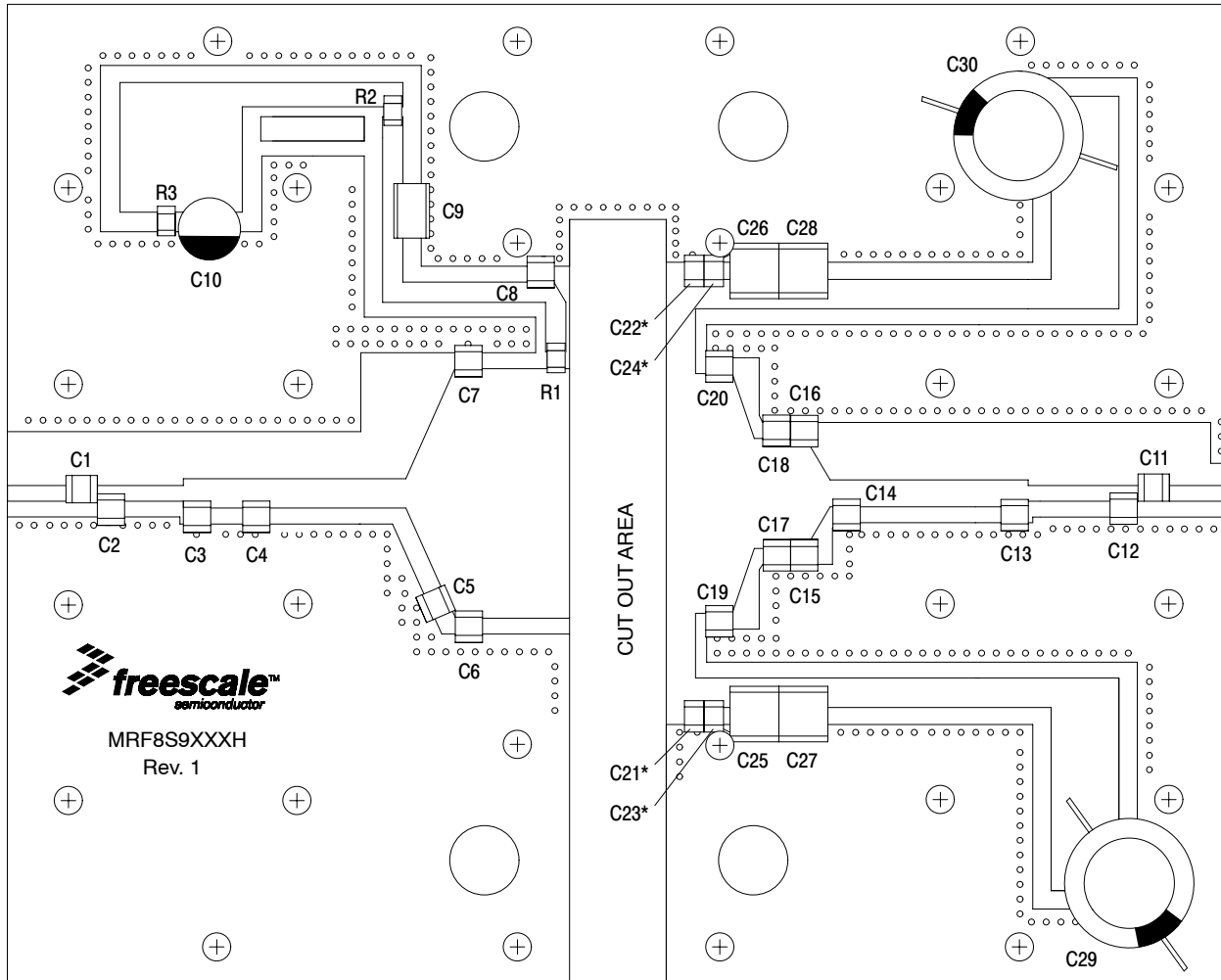
Frequency	G_{ps} (dB)	η_D (%)	Output PAR (dB)	ACPR (dB)	IRL (dB)
920 MHz	19.7	35.1	6.1	-37.4	-13
940 MHz	19.8	35.3	6.2	-37.5	-24
960 MHz	19.4	35.7	6.1	-37.4	-13

1. Part internally matched both on input and output.

(continued)

Table 4. Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted) (continued)

Characteristic	Symbol	Min	Typ	Max	Unit
Typical Performances (In Freescale Test Fixture, 50 ohm system) $V_{DD} = 28\text{ Vdc}$, $I_{DQ} = 1600\text{ mA}$, 920-960 MHz Bandwidth					
P_{out} @ 1 dB Compression Point, CW	P1dB	—	220	—	W
IMD Symmetry @ 200 W PEP, P_{out} where IMD Third Order Intermodulation $\cong 30\text{ dBc}$ (Delta IMD Third Order Intermodulation between Upper and Lower Sidebands $> 2\text{ dB}$)	IMD _{sym}	—	12	—	MHz
VBW Resonance Point (IMD Third Order Intermodulation Inflection Point)	VBW _{res}	—	40	—	MHz
Gain Flatness in 40 MHz Bandwidth @ $P_{out} = 65\text{ W Avg.}$	G _F	—	0.3	—	dB
Gain Variation over Temperature (-30°C to $+85^\circ\text{C}$)	ΔG	—	0.017	—	dB/ $^\circ\text{C}$
Output Power Variation over Temperature (-30°C to $+85^\circ\text{C}$)	ΔP_{1dB}	—	0.016	—	dBm/ $^\circ\text{C}$



*C21, C22, C23, and C24 are mounted vertically.

Figure 1. MRF8S9220HR3(HSR3) Test Circuit Component Layout

Table 5. MRF8S9220HR3(HSR3) Test Circuit Component Designations and Values

Part	Description	Part Number	Manufacturer
C1, C8, C11, C23, C24	39 pF Chip Capacitors	ATC100B390JT500XT	ATC
C2	0.3 pF Chip Capacitor	ATC100B0R3BT500XT	ATC
C3, C12	1.0 pF Chip Capacitors	ATC100B1R0BT500XT	ATC
C4, C14	1.2 pF Chip Capacitors	ATC100B1R2BT500XT	ATC
C5	0.7 pF Chip Capacitor	ATC100B0R7BT500XT	ATC
C6, C7, C21, C22	10 pF Chip Capacitors	ATC100B100JT500XT	ATC
C9	2.2 μ F, 50 V Chip Capacitor	C1825C225J5RAC-TU	Kemet
C10	47 μ F, 50 V Electrolytic Capacitor	476KXM050M	Illinois Capacitor
C13	1.3 pF Chip Capacitor	ATC100B1R3BT500XT	ATC
C15, C16	5.1 pF Chip Capacitors	ATC100B5R1CT500XT	ATC
C17	5.6 pF Chip Capacitor	ATC100B5R6CT500XT	ATC
C18	6.2 pF Chip Capacitor	ATC100B6R2BT500XT	ATC
C19, C20	6.8 pF Chip Capacitors	ATC100B6R8CT500XT	ATC
C25, C26, C27, C28	10 μ F, 50 V Chip Capacitors	GRM55DR61H106KA88L	Murata
C29, C30	470 μ F, 63 V Electrolytic Capacitors	MCGPR63V477M13X26-RH	Multicomp
R1	0 Ω , 3 A Chip Resistor	CRCW12060000Z0EA	Vishay
R2	3.3 Ω , 1/2 W Chip Resistor	P3.3VCT-ND	Panasonic
R3	2.2 k Ω , 1/4 W Chip Resistor	CRCW12062K20FKEA	Vishay
PCB	0.030", $\epsilon_r = 3.5$	RF-35	Taconic

TYPICAL CHARACTERISTICS

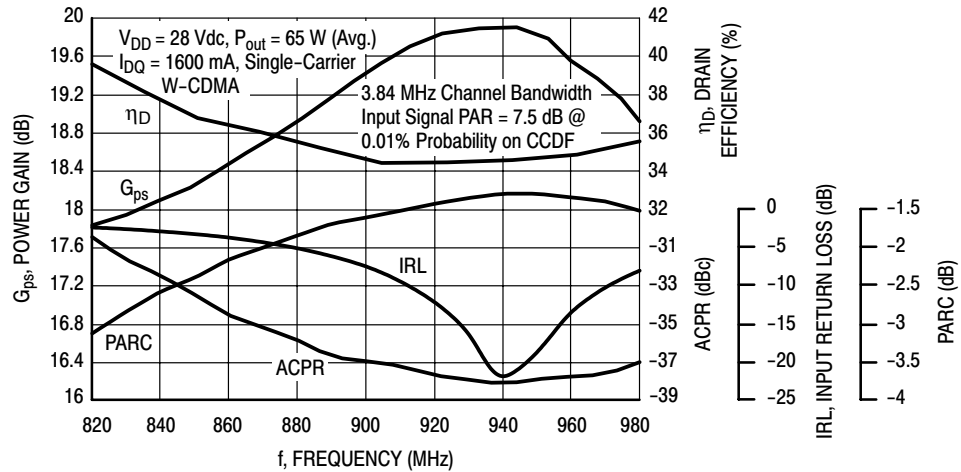


Figure 2. Output Peak-to-Average Ratio Compression (PARC) Broadband Performance @ $P_{out} = 65$ Watts Avg.

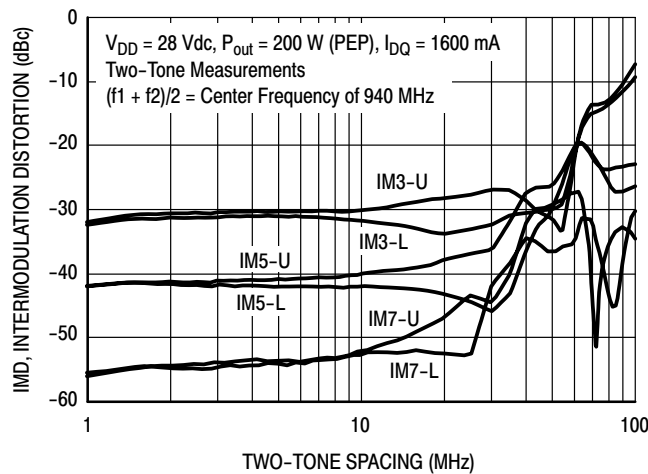


Figure 3. Intermodulation Distortion Products versus Two-Tone Spacing

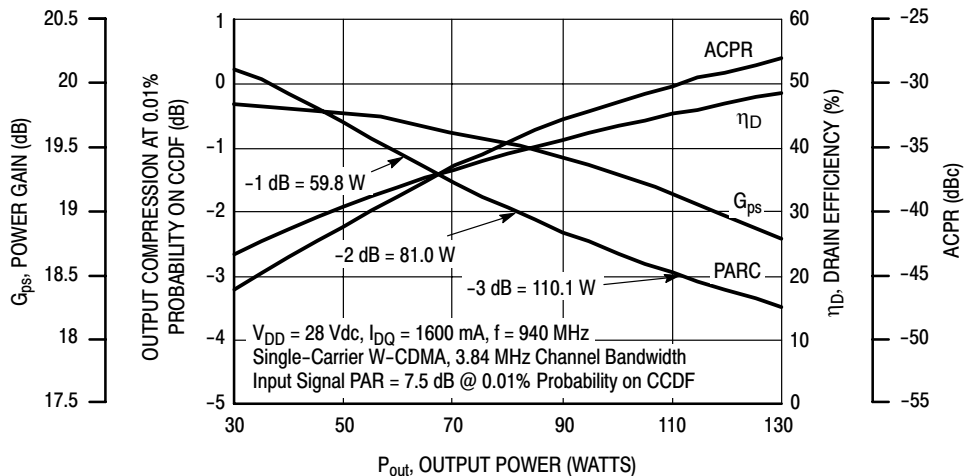


Figure 4. Output Peak-to-Average Ratio Compression (PARC) versus Output Power

TYPICAL CHARACTERISTICS

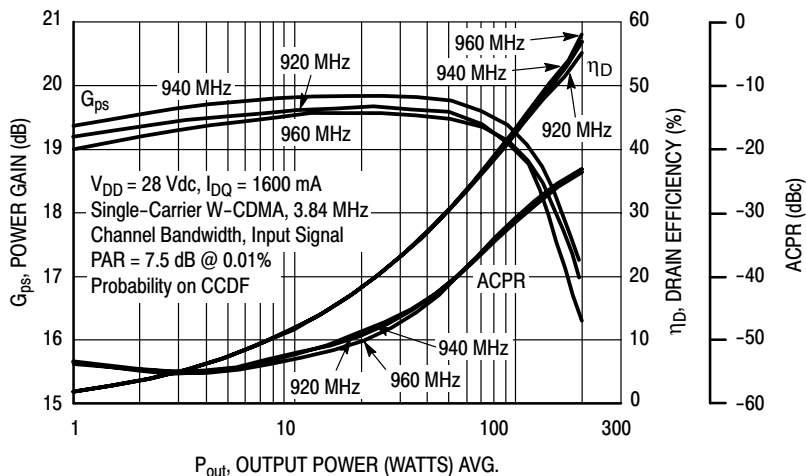


Figure 5. Single-Carrier W-CDMA Power Gain, Drain Efficiency and ACPR versus Output Power

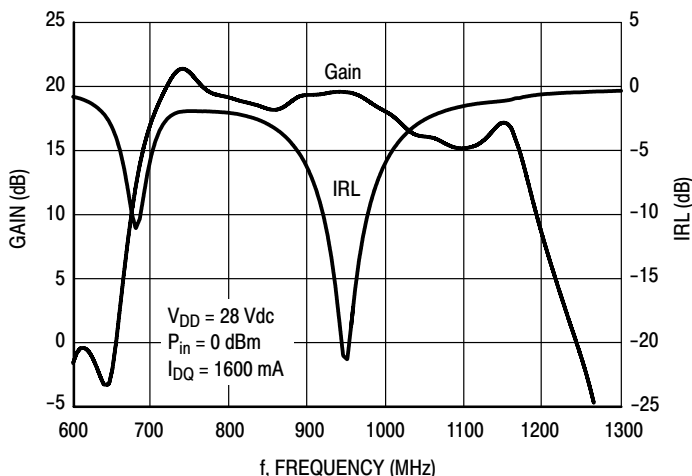


Figure 6. Broadband Frequency Response

W-CDMA TEST SIGNAL

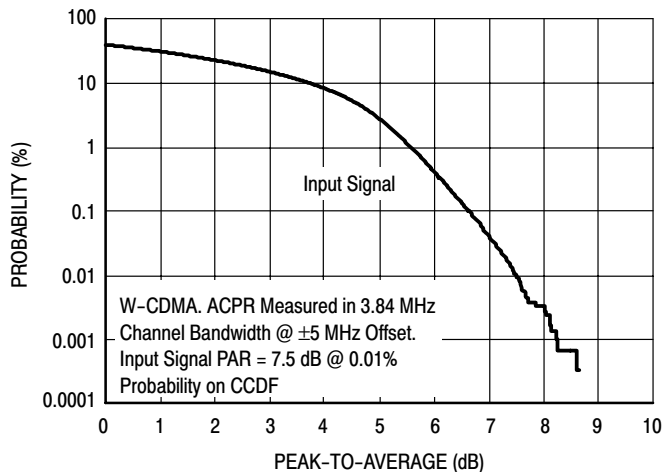


Figure 7. CCDF W-CDMA IQ Magnitude Clipping, Single-Carrier Test Signal

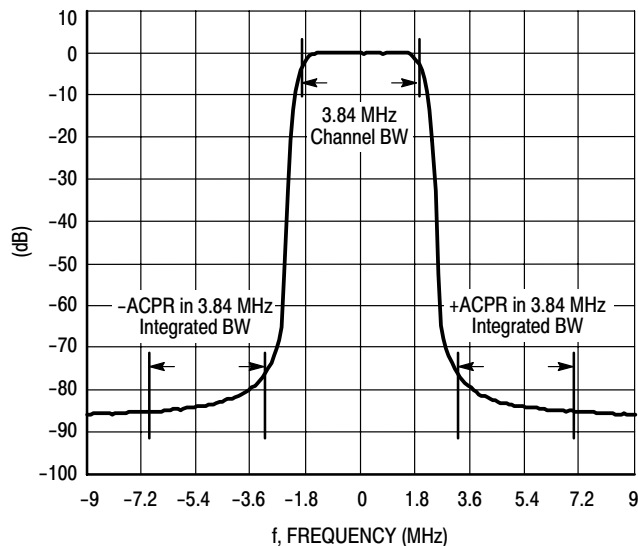


Figure 8. Single-Carrier W-CDMA Spectrum

$V_{DD} = 28 \text{ Vdc}$, $I_{DQ} = 1600 \text{ mA}$, $P_{out} = 65 \text{ W Avg.}$

f MHz	Z_{source} Ω	Z_{load} Ω
820	1.27 - j1.44	2.14 - j2.23
840	1.27 - j1.15	1.97 - j1.94
860	1.23 - j0.90	1.82 - j1.65
880	1.05 - j0.68	1.54 - j1.40
900	0.95 - j0.39	1.29 - j1.11
920	0.94 - j0.15	1.26 - j0.85
940	0.90 + j0.08	1.22 - j0.69
960	0.85 + j0.31	1.11 - j0.47
980	0.78 + j0.55	1.01 - j0.23

Z_{source} = Test circuit impedance as measured from gate to ground.

Z_{load} = Test circuit impedance as measured from drain to ground.

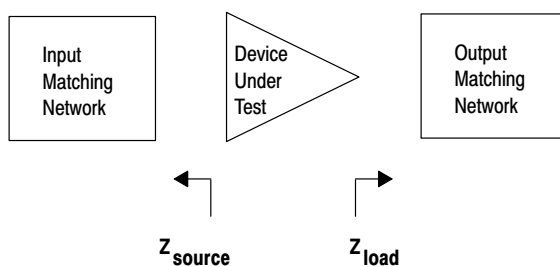
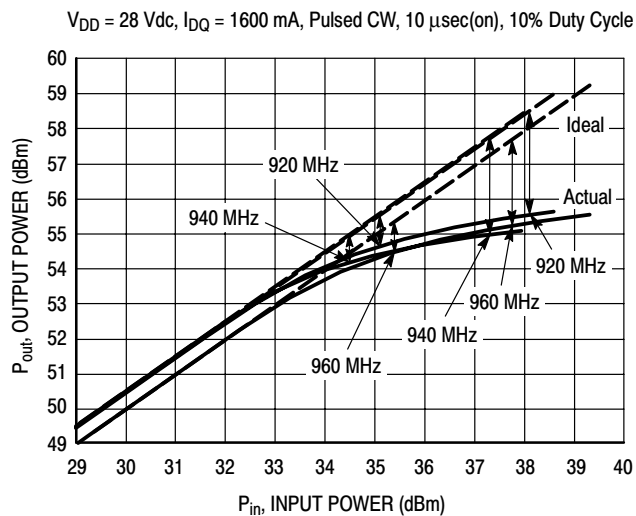


Figure 9. Series Equivalent Source and Load Impedance

ALTERNATIVE PEAK TUNE LOAD PULL CHARACTERISTICS



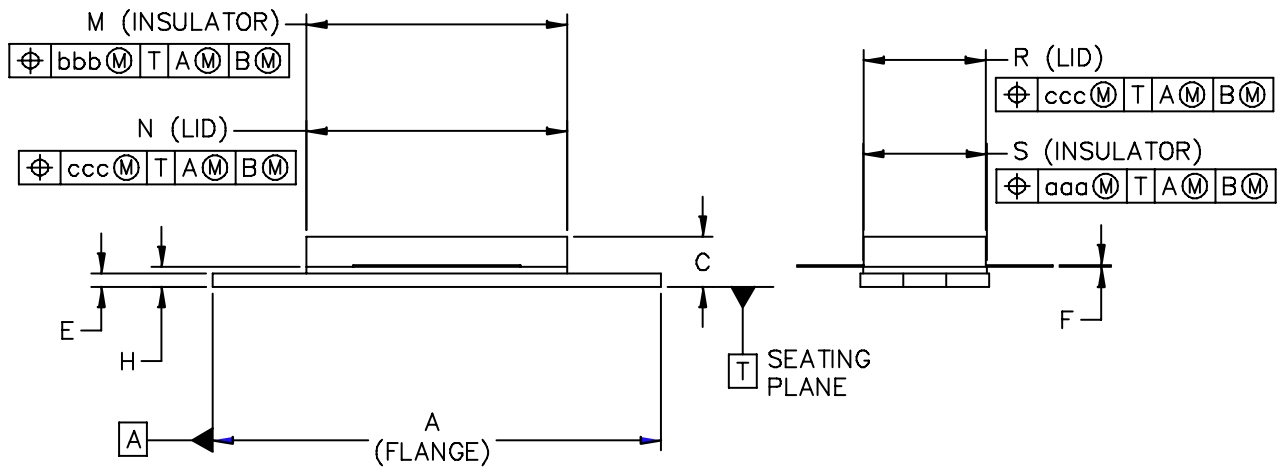
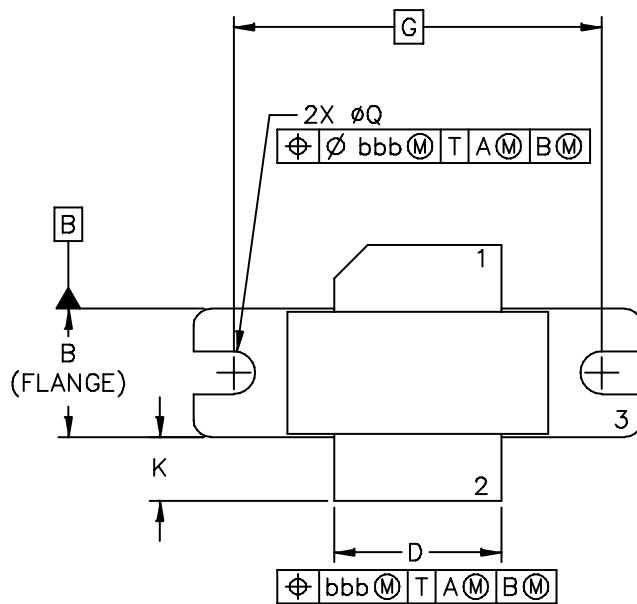
f (MHz)	P1dB		P3dB	
	Watts	dBm	Watts	dBm
920	295	54.7	357	55.5
940	270	54.3	316	55.0
960	284	54.5	344	55.4

Test Impedances per Compression Level

f (MHz)		Z_{source} Ω	Z_{load} Ω
920	P1dB	$0.630 - j1.26$	$0.791 - j1.16$
940	P1dB	$0.728 - j1.43$	$0.809 - j1.04$
960	P1dB	$0.886 - j1.68$	$0.853 - j1.28$

Figure 10. Pulsed CW Output Power versus Input Power @ 28 V

PACKAGE DIMENSIONS



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MRF8S9220HR3 MRF8S9220HSR3

NOTES:

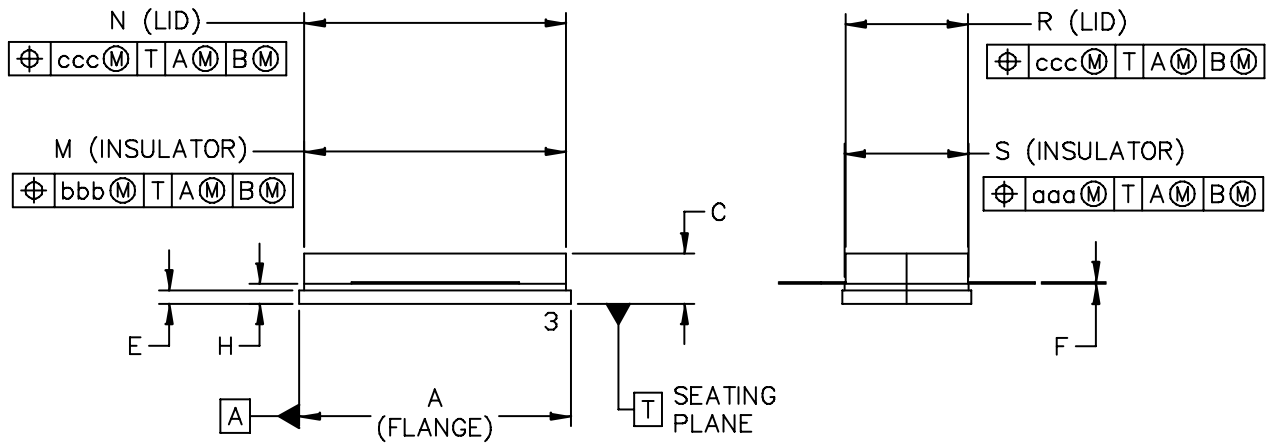
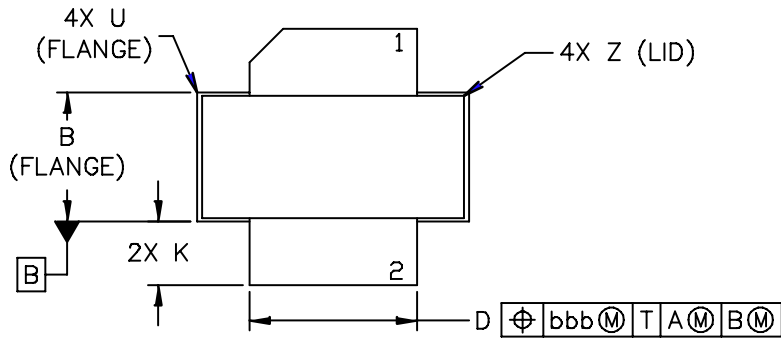
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2. CONTROLLING DIMENSION: INCH.
3. DELETED
4. DIMENSION H IS MEASURED .030 (.762) AWAY FROM PACKAGE BODY.

STYLE 1:

- PIN 1. DRAIN
 2. GATE
 3. SOURCE

DIM	INCH		MILLIMETER		DIM	INCH		MILLIMETER	
	MIN	MAX	MIN	MAX		MIN	MAX	MIN	MAX
A	1.335	– 1.345	33.91	– 34.16	R	.365	– .375	9.27	– 9.53
B	.380	– .390	9.65	– 9.91	S	.365	– .375	9.27	– 9.52
C	.125	– .170	3.18	– 4.32	aaa	– .005	–	–	0.127 –
D	.495	– .505	12.57	– 12.83	bbb	– .010	–	–	0.254 –
E	.035	– .045	0.89	– 1.14	ccc	– .015	–	–	0.381 –
F	.003	– .006	0.08	– 0.15	–	–	–	–	–
G	1.100 BSC		27.94 BSC		–	–	–	–	–
H	.057	– .067	1.45	– 1.7	–	–	–	–	–
K	.170	– .210	4.32	– 5.33	–	–	–	–	–
M	.774	– .786	19.66	– 19.96	–	–	–	–	–
N	.772	– .788	19.6	– 20	–	–	–	–	–
Q	∅.118	– ∅.138	∅3	– ∅3.51	–	–	–	–	–

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	CASE NUMBER: 465A-06	31 MAR 2005	
	STANDARD: NON-JEDEC		

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3. DELETED
4. DIMENSION H IS MEASURED .030 (0.762) AWAY FROM PACKAGE BODY.

STYLE 1:

- PIN 1. DRAIN
2. GATE
3. SOURCE

DIM	INCH		MILLIMETER		DIM	INCH		MILLIMETER	
	MIN	MAX	MIN	MAX		MIN	MAX	MIN	MAX
A	.805	– .815	20.45	– 20.7	U	–	– .040	–	– 1.02
B	.380	– .390	9.65	– 9.91	Z	–	– .030	–	– 0.76
C	.125	– .170	3.18	– 4.32	aaa	–	.005 –	–	0.127 –
D	.495	– .505	12.57	– 12.83	bbb	–	.010 –	–	0.254 –
E	.035	– .045	0.89	– 1.14	ccc	–	.015 –	–	0.381 –
F	.003	– .006	0.08	– 0.15	–	–	– –	–	– –
H	.057	– .067	1.45	– 1.7	–	–	– –	–	– –
K	.170	– .210	4.32	– 5.33	–	–	– –	–	– –
M	.774	– .786	19.61	– 20.02	–	–	– –	–	– –
N	.772	– .788	19.61	– 20.02	–	–	– –	–	– –
R	.365	– .375	9.27	– 9.53	–	–	– –	–	– –
S	.365	– .375	9.27	– 9.52	–	–	– –	–	– –

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		CASE NUMBER: 465A–06		31 MAR 2005	
		STANDARD: NON–JEDEC			

PRODUCT DOCUMENTATION, TOOLS AND SOFTWARE

Refer to the following documents to aid your design process.

Application Notes

- AN1955: Thermal Measurement Methodology of RF Power Amplifiers

Engineering Bulletins

- EB212: Using Data Sheet Impedances for RF LDMOS Devices

Software

- Electromigration MTTF Calculator
- RF High Power Model
- .s2p File

For Software and Tools, do a Part Number search at <http://www.freescale.com>, and select the "Part Number" link. Go to the Software & Tools tab on the part's Product Summary page to download the respective tool.

REVISION HISTORY

The following table summarizes revisions to this document.

Revision	Date	Description
0	Nov. 2009	<ul style="list-style-type: none">• Initial Release of Data Sheet

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